TOSHIBA TLSE 156P

TOSHIBA LED LAMP InGaA&P RED LIGHT EMISSION

TLSE156P

PANEL CIRCUIT INDICATOR

- 5 mm DIAMETER (T1-3/4)
- InGaA&P RED LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Red Light Emission Recommended Forward Current: IF = 15~20 mA (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- APPLICATIONS: Suitable for Outdoor Message Signboard, Safety equipment, automotive use.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Forward Current (DC)	$I_{\mathbf{F}}$	50	mA	
Reverse Voltage	v_{R}	4	V	
Power Dissipation	P_{D}	125	mW	
Operating Temperature Range	$T_{ m opr}$	-30~85	°C	
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~120	°C	

2. CATHODE JEDEC EIAJ TOSHIBA

Unit in mm

Weight: 0.31 g

ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F}=20~{ m mA}$		1.95	2.4	V
Reverse Current	I_{R}	$V_R = 4 V$	_	_	50	μ A
Luminous Intensity	$I_{ m V}$	$I_{\rm F}=20{ m mA}$ (Note)	272	900	_	mcd
Peak Emission Wavelength	$\lambda_{\mathbf{p}}$	$I_{ m F}=20{ m mA}$	_	623	_	nm
Spectral Line Half Width	Δλ	$I_{ m F}=20{ m mA}$	_	15	_	nm
Dominant Wavelength	$^{\lambda}\mathbf{d}$	$I_{ m F}=20{ m mA}$	_	613		nm

(Note): Lamps are classified into the following ranks according to their luminous intensity. Measurement tolerance for each limit is $\pm 15\%$.

 $Q:320\text{-}640\,\text{mcd},\ R:560\text{-}1120\,\text{mcd},\ S:1000\text{-}2000\,\text{mcd}.$

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Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic

garbage.

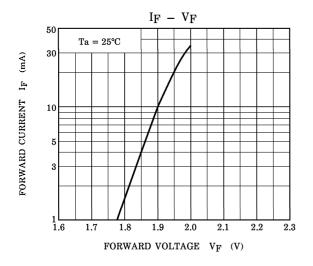
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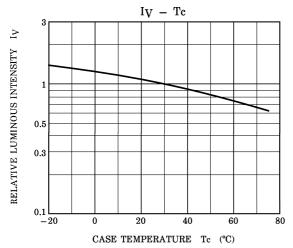
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PRECAUTION

Please be careful of the followings

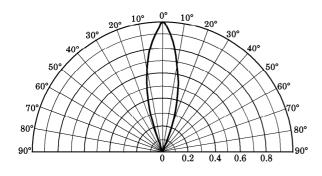
- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

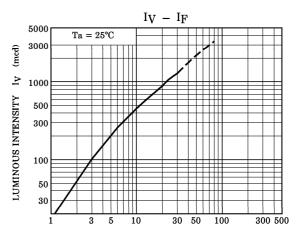






 $Ta = 25^{\circ}C$





FORWARD CURRENT $I_{\mbox{\scriptsize F}}$ (mA)

